



High Efficiency, Sine Amplitude Converter™

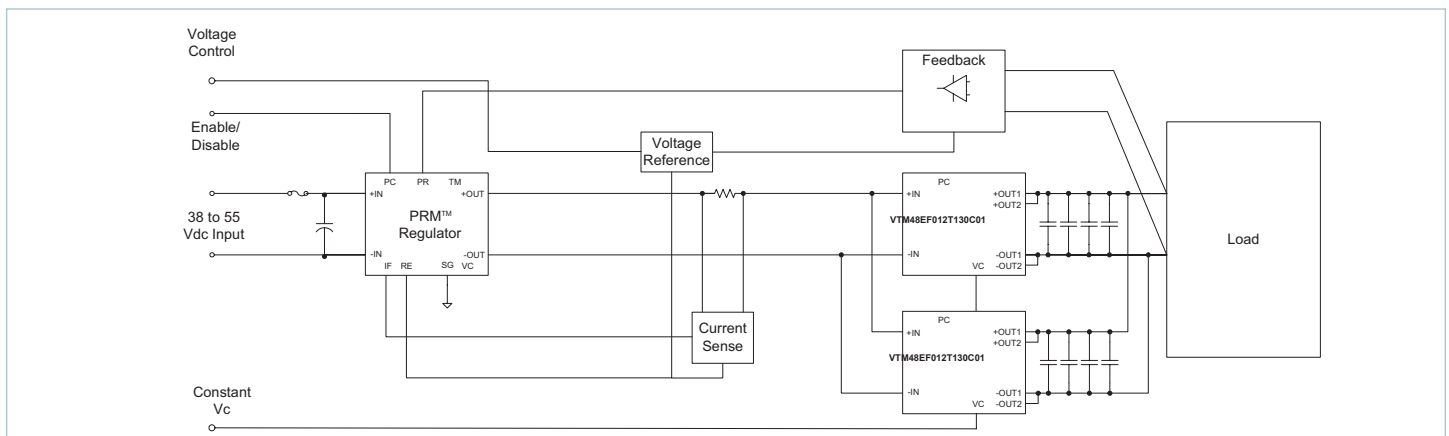
Features & Benefits

- Optimized for VR12.0
- 40V_{DC} to 1V_{DC} 130A current multiplier
 - Operating from standard 48V or 24V PRM™ regulators
- High efficiency (>94%) reduces system power consumption
- High density (443 A/in³)
- “Full Chip” VI Chip® package enables surface mount, low impedance interconnect to system board
- Contains built-in protection features against:
 - Overvoltage
 - Overtemperature
- Provides enable / disable control, internal temperature monitoring
- ZVS / ZCS resonant Sine Amplitude Converter topology
- Less than 50°C temperature rise at full load in typical applications

Typical Applications

- High End Computing Systems
- Automated Test Equipment
- High Density Power Supplies
- Communications Systems

Typical Application



Description

The VI Chip® current multiplier is a high efficiency (>94%) Sine Amplitude Converter™ (SAC) operating from a 26 to 55V_{DC} primary bus to deliver an isolated output. The Sine Amplitude Converter offers a low AC impedance beyond the bandwidth of most downstream regulators; therefore capacitance normally at the load can be located at the input to the Sine Amplitude Converter. Since the K factor of the VTM48EF012T130C01 is 1/40, the capacitance value can be reduced by a factor of 1600, resulting in savings of board area, materials and total system cost.

The VTM48EF012T130C01 is provided in a VI Chip package compatible with standard pick-and-place and surface mount assembly processes. The co-molded VI Chip package provides enhanced thermal management due to a large thermal interface area and superior thermal conductivity. The high conversion efficiency of the VTM48EF012T130C01 increases overall system efficiency and lowers operating costs compared to conventional approaches.

The VTM48EF012T130C01 enables the utilization of Factorized Power Architecture™ which provides efficiency and size benefits by lowering conversion and distribution losses and promoting high density point of load conversion.

Product Ratings	
V _{IN} = 26 to 55V	I _{OUT} = 130A (nom)
V _{OUT} = 0.7 to 1.4V (no load)	K = 1/40

Part Number	Description
VTM48EF012T130C01	-40°C to 125°C T _J

Absolute Maximum Ratings

The absolute maximum ratings below are stress ratings only. Operation at or beyond these maximum ratings can cause permanent damage to the device.

Parameter	Comments	Min	Max	Unit
+IN to -IN		-1.0	60	V _{DC}
PC to -IN		-0.3	20	V _{DC}
TM to -IN		-0.3	7	V _{DC}
VC to -IN		-0.3	20	V _{DC}
IM to -IN		0	3.15	V _{DC}
+IN / -IN to +OUT / -OUT (hipot)			1500	V _{DC}
+IN / -IN to +OUT / -OUT (working)			60	V _{DC}
+OUT to -OUT		-1.0	5.5	V _{DC}

Electrical Specifications

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of -40°C < T_J < 125°C (T-Grade); All other specifications are at T_J = 25°C unless otherwise noted.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Powertrain						
Input voltage range	V _{IN}	No external VC applied	26		55	Vdc
		VC applied	0		55	
V _{IN} slew rate	dV _{IN} /dt				1	V/μs
V _{IN} UV turn off	V _{IN_UV}	Module latched shutdown, No external VC applied, I _{OUT} = 130A		18	26	V
No Load power dissipation	P _{NL}	V _{IN} = 40V	1.5		5	W
		V _{IN} = 26V to 55V			6	
		V _{IN} = 40V, T _C = 25°C		2.2	3.5	
		V _{IN} = 26V to 55V, T _C = 25°C			4.5	
DC input current	I _{IN_DC}				4.5	A
Transfer ratio	K	K = V _{OUT} /V _{IN} , I _{OUT} = 0A		1/40		V/V
Output voltage	V _{OUT}	V _{OUT} = V _{IN} • K - I _{OUT} • R _{OUT} , Page 12				V
Output current (average)	I _{OUT_AVG}	30°C < T _C < 100°C, I _{OUT_MAX} = - (2/7) * T _C + 159			130	A
		T _C = 30°C			150	
Output current (peak)	I _{OUT_PK}	T _{PEAK} < 10ms, I _{OUT_AVG} ≤ 130A			195	A
Output power (average)	P _{OUT_AVG}	I _{OUT_AVG} ≤ 130A			178	W
Efficiency (ambient)	η _{AMB}	V _{IN} = 40V, I _{OUT} = 130A	88.0	90.4		%
		V _{IN} = 26V to 55V, I _{OUT} = 130A	82.5			
		V _{IN} = 40V, I _{OUT} = 65A	91	92.7		
		V _{IN} = 40V, I _{OUT} = 150A	87	89.2		
Efficiency (hot)	η _{HOT}	V _{IN} = 40V, T _C = 100°C, I _{OUT} = 130A	86.2	89.2		%
Efficiency (over load range)	η _{20%}	26A < I _{OUT} < 130A	80			%

Electrical Specifications (Cont.)

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$ (T-Grade); All other specifications are at $T_J = 25^{\circ}\text{C}$ unless otherwise noted.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Powertrain (Cont.)						
Output resistance (cold)	R_{OUT_COLD}	$T_C = -40^{\circ}\text{C}$, $I_{OUT} = 130\text{A}$	0.25	0.44	0.72	$\text{m}\Omega$
Output resistance (ambient)	R_{OUT_AMB}	$T_C = 25^{\circ}\text{C}$, $I_{OUT} = 130\text{A}$	0.45	0.59	0.80	$\text{m}\Omega$
Output resistance (hot)	R_{OUT_HOT}	$T_C = 100^{\circ}\text{C}$, $I_{OUT} = 130\text{A}$	0.57	0.68	0.94	$\text{m}\Omega$
Switching frequency	F_{SW}		1.14	1.20	1.26	MHz
Output ripple frequency	F_{SW_RP}		2.28	2.40	2.52	MHz
Output voltage ripple	V_{OUT_PP}	$C_{OUT} = 0\text{F}$, $I_{OUT} = 130\text{A}$, $V_{IN} = 40\text{V}$, 20MHz BW		125	175	mV
Output inductance (parasitic)	L_{OUT_PAR}	Frequency up to 30MHz, Simulated J-lead model		150		pH
Output capacitance (internal)	C_{OUT_INT}	Effective Value at $1V_{OUT}$		530		μF
Output capacitance (external)	C_{OUT}	VTM Standalone Operation. V_{IN} pre-applied, VC enable			64400	μF
Protection						
Overvoltage lockout	V_{IN_OVLO+}	Module latched shutdown	55.1	58.1	59.9	V
Overvoltage lockout response time constant	T_{OVLO}	Effective internal RC filter		0.25		μs
Output overcurrent trip	I_{OCP}		N/A	N/A	N/A	A
Short circuit protection trip current	I_{SCP}		N/A			A
Output overcurrent response time constant	T_{OCP}	Effective internal RC filter (Integrative)		N/A		ms
Short circuit protection response time	T_{SCP}	From detection to cessation of switching (Instantaneous)		N/A		μs
Thermal shutdown setpoint	T_{J_OTP}		125	130	135	$^{\circ}\text{C}$
Reverse inrush current protection		Reverse Inrush protection is enabled for this product				

Signal Characteristics

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of $-40^{\circ}\text{C} \leq T_J < 125^{\circ}\text{C}$ (T-Grade); All other specifications are at $T_J = 25^{\circ}\text{C}$ unless otherwise noted.

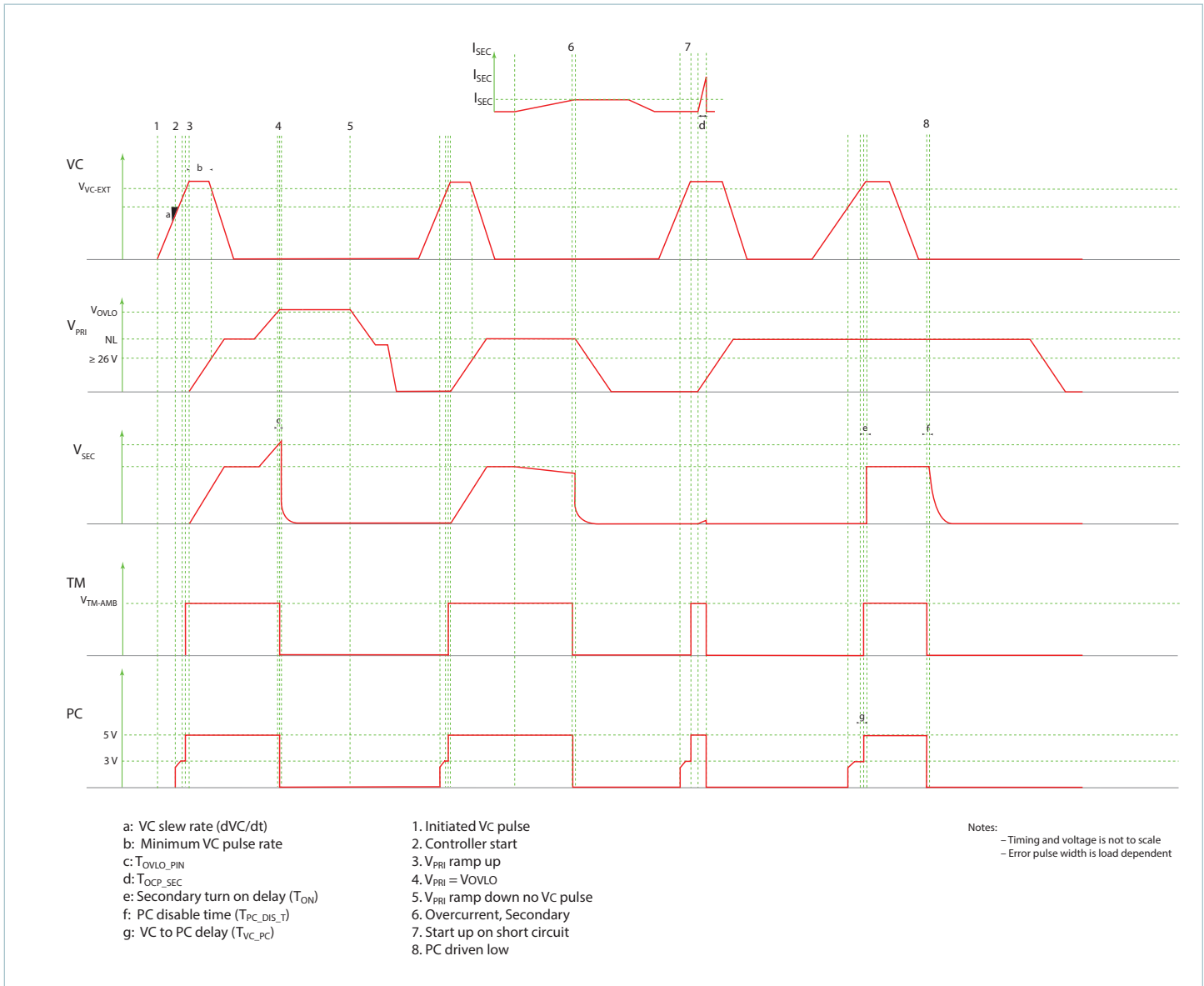
VTM Control : VC									
<ul style="list-style-type: none"> Used to wake up powertrain circuit. A minimum of 11.5V must be applied indefinitely for $V_{IN} < 26\text{V}$ to ensure normal operation. VC slew rate must be within range for a successful start. PRM™ module VC can be used as valid wake-up signal source. Internal Resistance used in "Adaptive Loop" compensation. VC voltage may be continuously applied. 									
SIGNAL TYPE	STATE	ATTRIBUTE	SYMBOL	CONDITIONS / NOTES	MIN	TYP	MAX	UNIT	
ANALOG INPUT	Steady	External VC voltage	V_{VC_EXT}	Required for start up, and operation below 26V.	11.5		16.5	V	
		VC current draw	I_{VC}	$VC = 11.5\text{V}, V_{IN} = 0\text{V}$		115	150	mA	
				$VC = 11.5\text{V}, V_{IN} > 26\text{V}$		0			
				$VC = 16.5\text{V}, V_{IN} > 26\text{V}$		0			
				Fault mode. $VC > 11.5\text{V}$		60			
	VC internal diode rating	D_{VC_INT}			100		V		
	VC internal resistor	R_{VC_INT}				N/A	$k\Omega$		
	VC internal resistor temperature coefficient	T_{VC_COEFF}					N/A	ppm/°C	
	Start Up	VC start up pulse	V_{VC_SP}	$T_{peak} < 18\text{ms}$				20	V
		VC slew rate	dVC/dt	Required for proper start up		0.02		0.25	V/μs
VC inrush current		I_{INR_VC}	$VC = 16.5\text{V}, dVC/dt = 0.25\text{V}/\mu\text{s}$				1	A	
Transitional	VC to V_{OUT} turn-on delay	T_{ON}	V_{IN} pre-applied, PC floating, VC enable, $C_{PC} = 0\mu\text{F}$				500	μs	
	VC to PC delay	T_{VC_PC}	$VC = 11.5\text{V}$ to PC high, $V_{IN} = 0\text{V}$, $dVC/dt = 0.25\text{V}/\mu\text{s}$		75	125		μs	
	Internal VC capacitance	C_{VC_INT}	$VC = 0\text{V}$			3.2		μF	
PRIMARY CONTROL : PC									
<ul style="list-style-type: none"> The PC pin enables and disables the VTM module. When held below 2V, the VTM module will be disabled. PC pin outputs 5V during normal operation. PC pin is equal to 2.5V during fault mode given $V_{IN} > 26\text{V}$ or $VC > 11.5\text{V}$. After successful start up and under no fault condition, PC can be used as a 5V regulated voltage source with a 2mA maximum current. Module will shutdown when pulled low with an impedance less than 400Ω. In an array of VTM modules, connect PC pin to synchronize start up. PC pin cannot sink current and will not disable other modules during fault mode. 									
SIGNAL TYPE	STATE	ATTRIBUTE	SYMBOL	CONDITIONS / NOTES	MIN	TYP	MAX	UNIT	
ANALOG OUTPUT	Steady	PC voltage	V_{PC}		4.7	5	5.3	V	
		PC source current	I_{PC_OP}				2	mA	
		PC resistance (internal)	R_{PC_INT}	Internal pull down resistor		50	150	400	$k\Omega$
	Start Up	PC source current	I_{PC_EN}			50	100	300	μA
		PC capacitance (internal)	C_{PC_INT}					1000	pF
		PC resistance (external)	R_{PC_S}			60			$k\Omega$
DIGITAL INPUT / OUTPUT	Enable	PC voltage	V_{PC_EN}		2	2.5	3	V	
	Disable	PC voltage (disable)	V_{PC_DIS}				2	V	
		PC pull down current	I_{PC_PD}			5.1			mA
	Transitional	PC disable time	$T_{PC_DIS_T}$				5		μs
		PC fault response time	T_{FR_PC}	From fault to PC = 2V			100		μs

Signal Characteristics

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of $-40^{\circ}\text{C} \leq T_J < 125^{\circ}\text{C}$ (T-Grade); All other specifications are at $T_J = 25^{\circ}\text{C}$ unless otherwise noted.

CURRENT MONITOR : IM								
<ul style="list-style-type: none"> The IM pin voltage varies between 0.1V and 0.99V representing the output current within $\pm 25\%$ under all operating line temperature conditions between 50% and 100%. The IM pin provides a DC analog voltage proportional to the output current of the VTM module. 								
SIGNAL TYPE	STATE	ATTRIBUTE	SYMBOL	CONDITIONS / NOTES	MIN	TYP	MAX	UNIT
ANALOG OUTPUT	Steady	IM Voltage (No Load)	V_{IM_NL}	$T_J = 25^{\circ}\text{C}, V_{IN} = 40\text{V}, I_{OUT} = 0\text{A}$	0.1	0.15	0.3	V
		IM Voltage (50%)	$V_{IM_50\%}$	$T_J = 25^{\circ}\text{C}, V_{IN} = 40\text{V}, I_{OUT} = 65\text{A}$		0.48		V
		IM Voltage (Full Load)	V_{IM_FL}	$T_J = 25^{\circ}\text{C}, V_{IN} = 40\text{V}, I_{OUT} = 130\text{A}$		0.99		V
		IM Gain	A_{IM}	$T_J = 25^{\circ}\text{C}, V_{IN} = 40\text{V}, I_{OUT} > 65\text{A}$		7.8		mV/A
		IM Resistance (External)	R_{IM_EXT}		2.5			M Ω
TEMPERATURE MONITOR : TM								
<ul style="list-style-type: none"> The TM pin monitors the internal temperature of the VTM controller IC within an accuracy of $\pm 5^{\circ}\text{C}$. Can be used as a "Power Good" flag to verify that the VTM module is operating. The TM pin has a room temperature setpoint of 3V and approximate gain of 10mV/$^{\circ}\text{C}$. Output drives Temperature Shutdown comparator. 								
SIGNAL TYPE	STATE	ATTRIBUTE	SYMBOL	CONDITIONS / NOTES	MIN	TYP	MAX	UNIT
ANALOG OUTPUT	Steady	TM voltage	V_{TM_AMB}	$T_J \text{ controller} = 27^{\circ}\text{C}$	2.95	3.00	3.05	V
		TM source current	I_{TM}				100	μA
		TM gain	A_{TM}			10		mV/ $^{\circ}\text{C}$
		TM voltage ripple	V_{TM_PP}	$C_{TM} = 0\text{F}, V_{IN} = 40\text{V}, I_{OUT} = 130\text{A}$		120	200	mV
DIGITAL OUTPUT (FAULT FLAG)	Disable	TM voltage	V_{TM_DIS}			0		V
	Transitional	TM resistance (internal)	R_{TM_INT}	Internal pull down resistor	25	40	50	k Ω
		TM capacitance (external)	C_{TM_EXT}				50	pF
		TM fault response time	T_{FR_TM}	From fault to TM = 1.5V		10		μs

Timing Diagram



Application Characteristics

The following values, typical of an application environment, are collected at $T_C = 25^\circ\text{C}$ unless otherwise noted. See associated figures for general trend data.

Attribute	Symbol	Conditions / Notes	Typ	Unit
Powertrain				
No load power dissipation	P_{NL}	$V_{IN} = 40\text{V}$, PC enabled	1.9	W
Efficiency (ambient)	η_{AMB}	$V_{IN} = 40\text{V}$, $I_{OUT} = 130\text{A}$	90.6	%
Efficiency (hot)	η_{HOT}	$V_{IN} = 40\text{V}$, $I_{OUT} = 130\text{A}$, $T_C = 100^\circ\text{C}$	88.9	%
Output resistance (cold)	R_{OUT_COLD}	$V_{IN} = 40\text{V}$, $I_{OUT} = 130\text{A}$, $T_C = -40^\circ\text{C}$	0.54	$\text{m}\Omega$
Output resistance (ambient)	R_{OUT_AMB}	$V_{IN} = 40\text{V}$, $I_{OUT} = 130\text{A}$	0.62	$\text{m}\Omega$
Output resistance (hot)	R_{OUT_HOT}	$V_{IN} = 40\text{V}$, $I_{OUT} = 130\text{A}$, $T_C = 100^\circ\text{C}$	0.75	$\text{m}\Omega$
Output voltage ripple	V_{OUT_PP}	$C_{OUT} = 0\text{F}$, $I_{OUT} = 130\text{A}$, $V_{IN} = 40\text{V}$, 20MHz BW, Page 14	97	mV
V_{OUT} transient (positive)	V_{OUT_TRAN+}	$I_{OUT_STEP} = 0\text{A TO } 130\text{A}$, $V_{IN} = 40\text{V}$, $I_{SLEW} = 12\text{A}/\mu\text{s}$	145	mV
V_{OUT} transient (negative)	V_{OUT_TRAN-}	$I_{OUT_STEP} = 130\text{A TO } 0\text{A}$, $V_{IN} = 40\text{V}$, $I_{SLEW} = 26\text{A}/\mu\text{s}$	445	mV

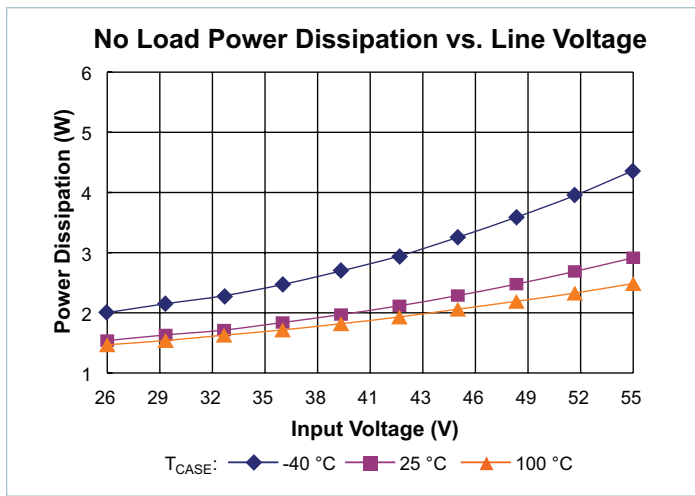


Figure 1 — No load power dissipation vs. V_{IN}

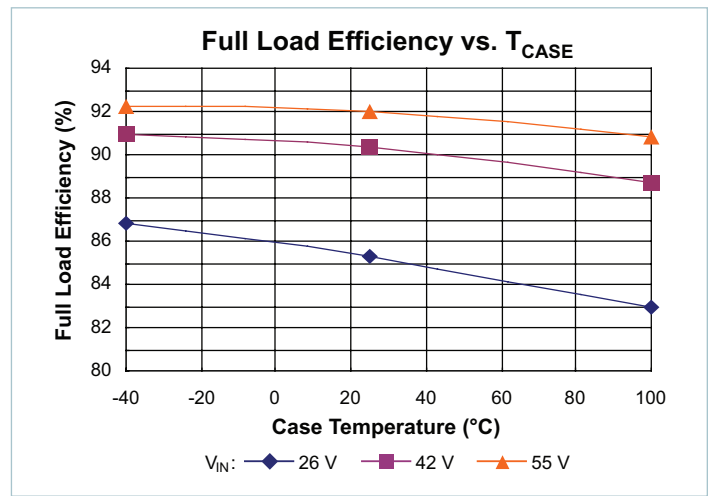


Figure 2 — Full load efficiency vs. temperature

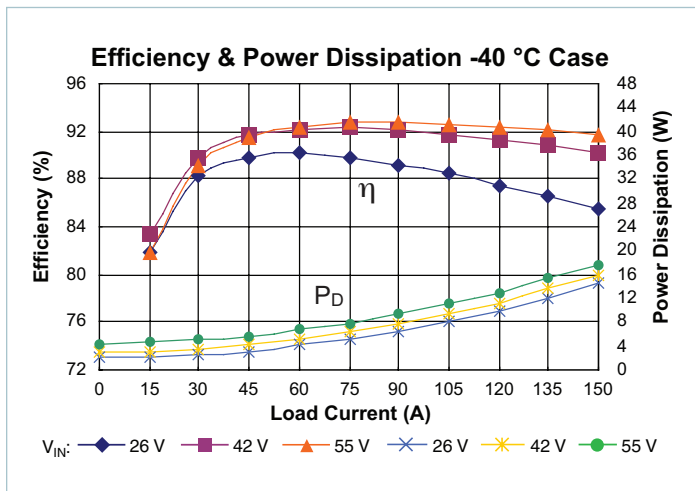


Figure 3 — Efficiency and power dissipation at -40°C

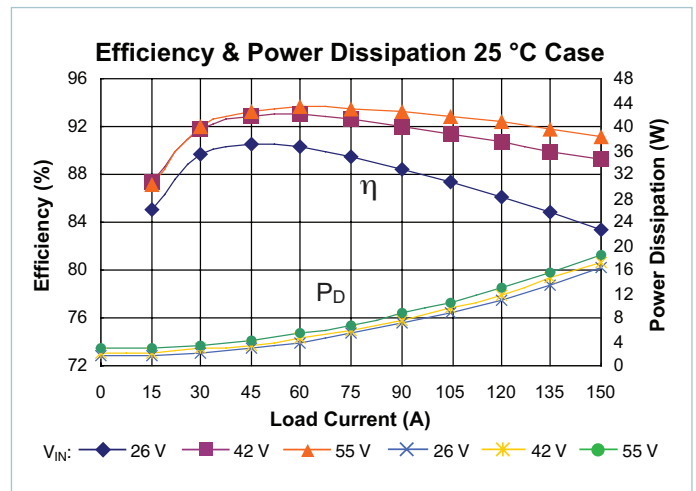


Figure 4 — Efficiency and power dissipation at 25°C

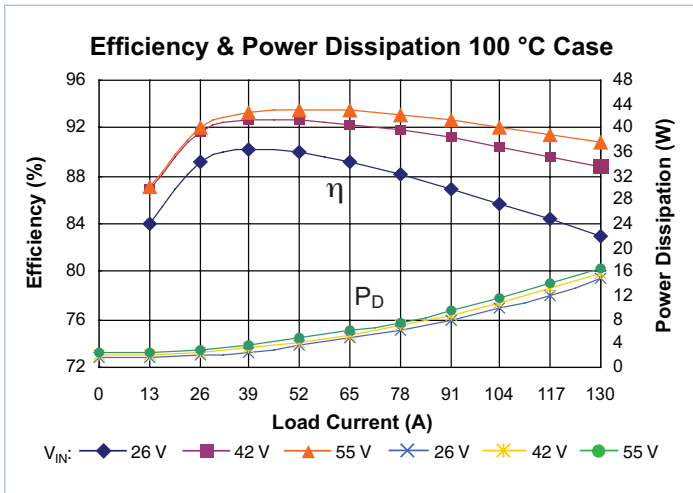


Figure 5 — Efficiency and power dissipation at 100°C

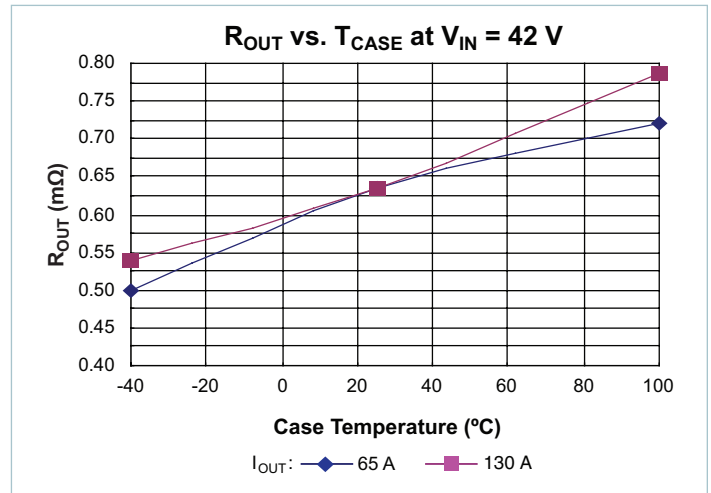


Figure 6 — R_{OUT} vs. temperature

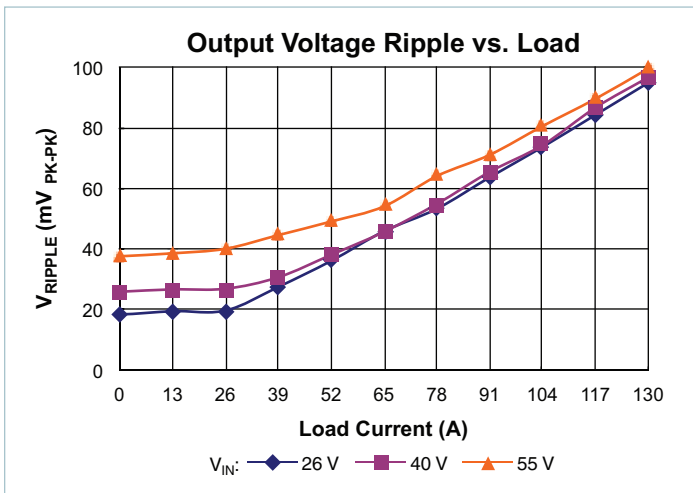


Figure 7 — V_{RIPPLE} vs. I_{OUT} ; No external C_{OUT} . Board mounted module, scope setting: 20MHz analog BW

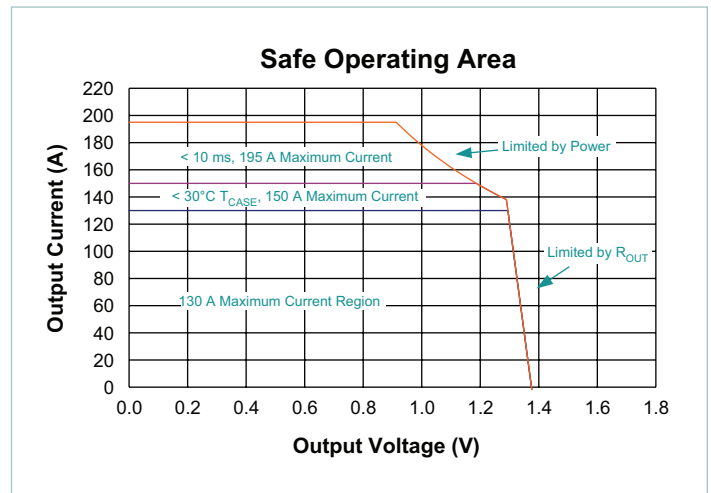


Figure 8 — Safe operating area

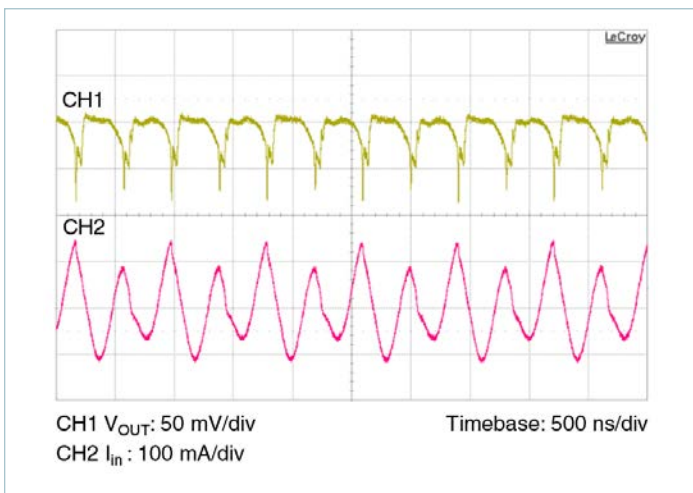


Figure 9 — Full load ripple, 100µF C_{IN} ; No external C_{OUT} . Board mounted module, scope setting : 20MHz analog BW

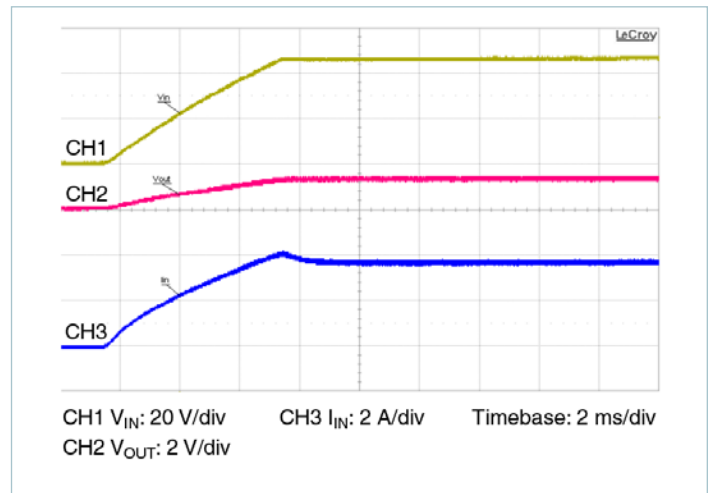


Figure 10 — Start up from application of V_{IN} ; VC pre-applied $C_{OUT} = 64400\mu F$

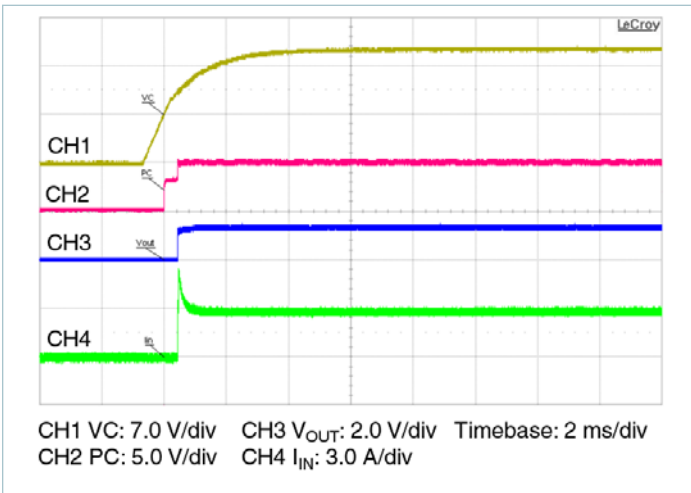


Figure 11 — Start up from application of VC;
 V_{IN} pre-applied $C_{OUT} = 64400\mu F$

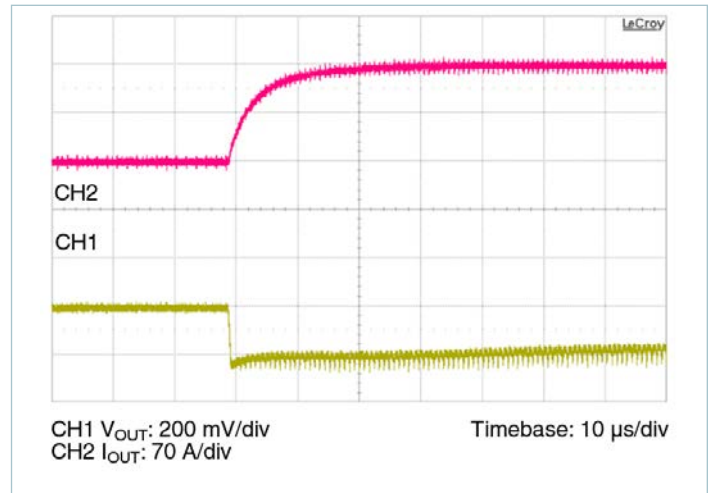


Figure 12 — 0A – 130A transient response:
 $C_{IN} = 100\mu F$, no external C_{OUT}

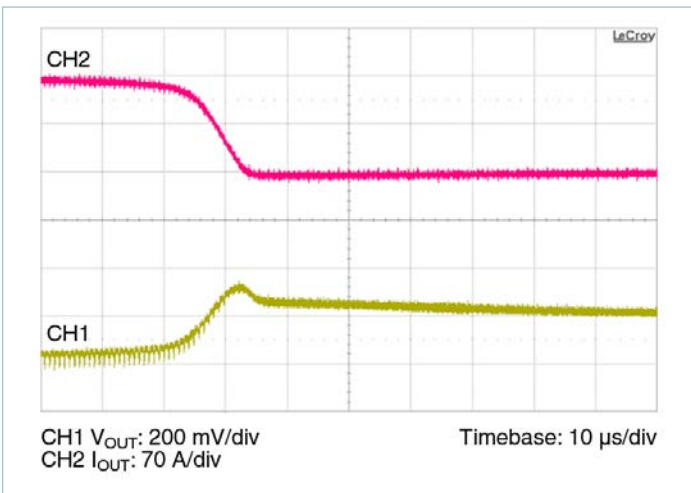


Figure 13 — 130A – 0A transient response:
 $C_{IN} = 100\mu F$, no external C_{OUT}

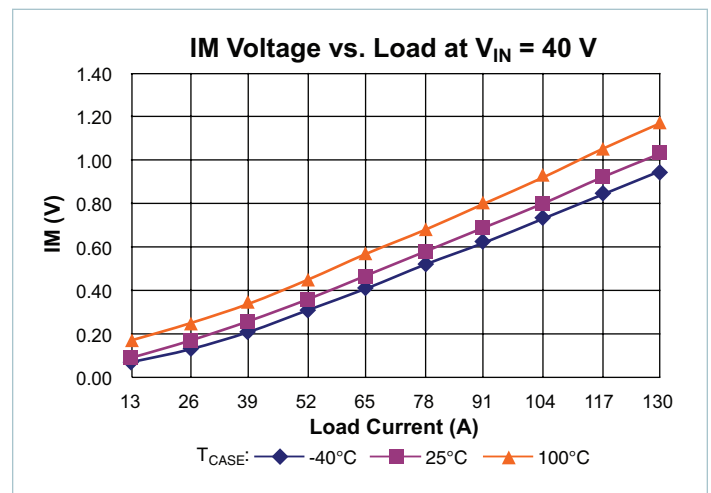


Figure 14 — IM voltage vs. load

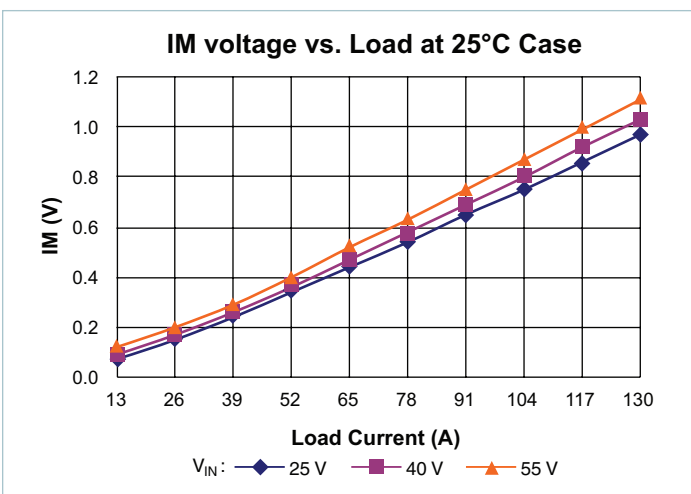


Figure 15 — IM voltage vs. load

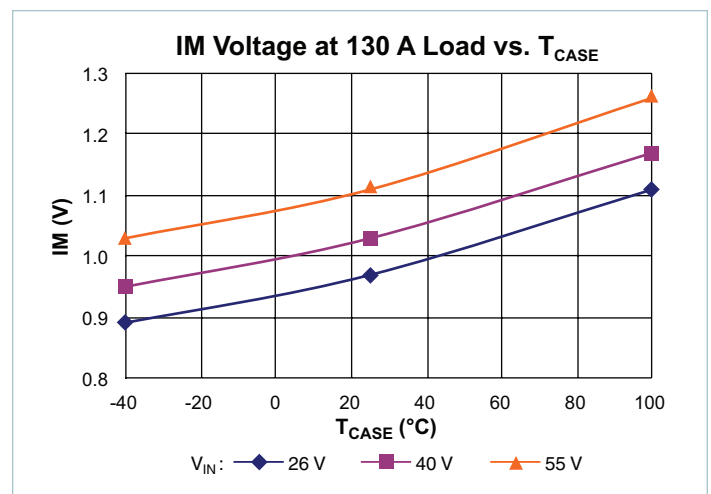


Figure 16 — Full load IM voltage vs. T_{CASE}

General Characteristics

Specifications apply over all line and load conditions unless otherwise noted; **Boldface** specifications apply over the temperature range of $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$ (T-Grade); All Other specifications are at $T_J = 25^{\circ}\text{C}$ unless otherwise noted.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Mechanical						
Length	L		32.25 / [1.270]	32.5 / [1.280]	32.75 / [1.289]	mm/[in]
Width	W		21.75 / [0.856]	22.0 / [0.866]	22.25 / [0.876]	mm/[in]
Height	H		6.48 / [0.255]	6.73 / [0.265]	6.98 / [0.275]	mm/[in]
Volume	Vol	No heat sink		4.81 / [0.294]		cm ³ /[in ³]
Weight	W			14.5 / [0.512]		g/[oz]
Lead Finish		Nickel	0.51		2.03	μm
		Palladium	0.02		0.15	
		Gold	0.003		0.051	
Thermal						
Operating temperature	T _J	VTM48EF012T130C01 (T-Grade)	-40		125	°C
Thermal resistance	ϕ _{JC}	Isothermal heatsink and isothermal internal PCB		1		°C/W
Thermal capacity				9		Ws/°C
Assembly						
Peak compressive force applied to case (Z-axis)		Supported by J-Lead only			6	lbs
					5.41	lbs/in ²
Storage temperature	T _{ST}	VTM48EF012T130C01 (T-Grade)	-40		125	°C
ESD withstand	ESD _{HBM}	Human Body Model, "JEDEC JESD 22-A114D"	1000			Vdc
	ESD _{CDM}	Charge Device Model, "JEDEC JESD 22-C101-D"	400			
Soldering						
Peak temperature during reflow		MSL 4 (Datecode 1528 and later)			245	°C
Peak time above 217°C				60	90	s
Peak heating rate during reflow				1.5	3	°C/s
Peak cooling rate post reflow				1.5	6	°C/s
Safety						
Working voltage (IN – OUT)	V _{IN_OUT}				60	V _{DC}
Isolation voltage (hipot)	V _{HIPOUT}	Applies to product built after April 2012 (post datecode 1219)	1500			V _{DC}
Isolation capacitance	C _{IN_OUT}	Unpowered unit	18000	20000	22000	pF
Isolation resistance	R _{IN_OUT}		10			MΩ
MTBF		MIL-HDBK-217 Plus Parts Count; 25°C Ground Benign, Stationary, Indoors / Computer Profile		4.01		MHrs
		Telcordia Issue 2 - Method I Case III; Ground Benign, Controlled		9.23		MHrs
Agency approvals / standards		cTUVus				
		cURus				
		CE Marked for Low Voltage Directive and RoHS Recast Directive, as applicable				

Using the control signals VC, PC, TM, IM

The **VTM Control (VC)** pin is an input pin which powers the internal VCC circuitry when within the specified voltage range of 11.5V to 16.5V. This voltage is required for VTM current multiplier start up and must be applied as long as the input is below 26V. In order to ensure a proper start, the slew rate of the applied voltage must be within the specified range.

Some additional notes on the using the VC pin:

- In most applications, the VTM module will be powered by an upstream PRM™ regulator which provides a 10ms VC pulse during start up. In these applications the VC pins of the PRM module and VTM module should be tied together.
- The VC voltage can be applied indefinitely allowing for continuous operation down to $0V_{IN}$.
- The fault response of the VTM module is latching. A positive edge on VC is required in order to restart the unit. If VC is continuously applied the PC pin may be toggled to restart the VTM module.

Primary Control (PC) pin can be used to accomplish the following functions:

- Delayed start: Upon the application of VC, the PC pin will source a constant 100µA current to the internal RC network. Adding an external capacitor will allow further delay in reaching the 2.5V threshold for module start.
- Auxiliary voltage source: Once enabled in regular operational conditions (no fault), each VTM PC provides a regulated 5V, 2mA voltage source.
- Output disable: PC pin can be actively pulled down in order to disable the module. Pull down impedance shall be lower than 400Ω.
- Fault detection flag: The PC 5V voltage source is internally turned off as soon as a fault is detected. It is important to notice that PC doesn't have current sink capability. Therefore, in an array, PC line will not be capable of disabling neighboring modules if a fault is detected.
- Fault reset: PC may be toggled to restart the unit if VC is continuously applied.

Temperature Monitor (TM) pin provides a voltage proportional to the absolute temperature of the converter control IC.

It can be used to accomplish the following functions:

- Monitor the control IC temperature: The temperature in Kelvin is equal to the voltage on the TM pin scaled by 100. (i.e. 3.0V = 300K = 27°C). If a heat sink is applied, TM can be used to thermally protect the system.
- Fault detection flag: The TM voltage source is internally turned off as soon as a fault is detected. For system monitoring purposes (microcontroller interface) faults are detected on falling edges of TM signal.

Current Monitor (IM) pin provides a voltage proportional to the output current of the VTM module. The nominal voltage will vary between 0.15V and 0.99V over the output current range of the VTM module (See Figures 14 – 16). The accuracy of the IM pin will be within 25% under all line and temperature conditions between 50% and 100% load.

START UP Behavior

Depending on the sequencing of the VC with respect to the input voltage, the behavior during start up will vary as follows:

- Normal operation (VC applied prior to V_{IN}): In this case the controller is active prior to ramping the input. When the input voltage is applied, the VTM module output voltage will track the input (See Figure 10). The inrush current is determined by the input voltage rate of rise and output capacitance. If the VC voltage is removed prior to the input reaching 26V, the VTM may shut down.
- Stand-alone operation (VC applied after V_{IN}): In this case the VTM module output will begin to rise upon the application of the VC voltage (See Page 12). The Adaptive Soft Start Circuit (See Page 12) may vary the output rate of rise in order to limit the inrush current to its maximum level. When starting into high capacitance, or a short, the output current will be limited for a maximum of 120µ/sec. After this period, the Adaptive Soft Start Circuit will time out and the VTM module may shut down. No restart will be attempted until VC is re-applied or PC is toggled. The maximum output capacitance is limited to 64400µF in this mode of operation to ensure a successful start.

Thermal Considerations

VI Chip® products are multi-chip modules whose temperature distribution varies greatly for each part number as well as with the input / output conditions, thermal management and environmental conditions. Maintaining the top of the VTM48EF012T130C01 case to less than 100°C will keep all junctions within the VI Chip module below 125°C for most applications.

The percent of total heat dissipated through the top surface versus through the J-lead is entirely dependent on the particular mechanical and thermal environment. The heat dissipated through the top surface is typically 60%. The heat dissipated through the J-lead onto the PCB board surface is typically 40%. Use 100% top surface dissipation when designing for a conservative cooling solution.

It is not recommended to use a VI Chip module for an extended period of time at full load without proper heat sinking.

Sine Amplitude Converter™ Point of Load Conversion

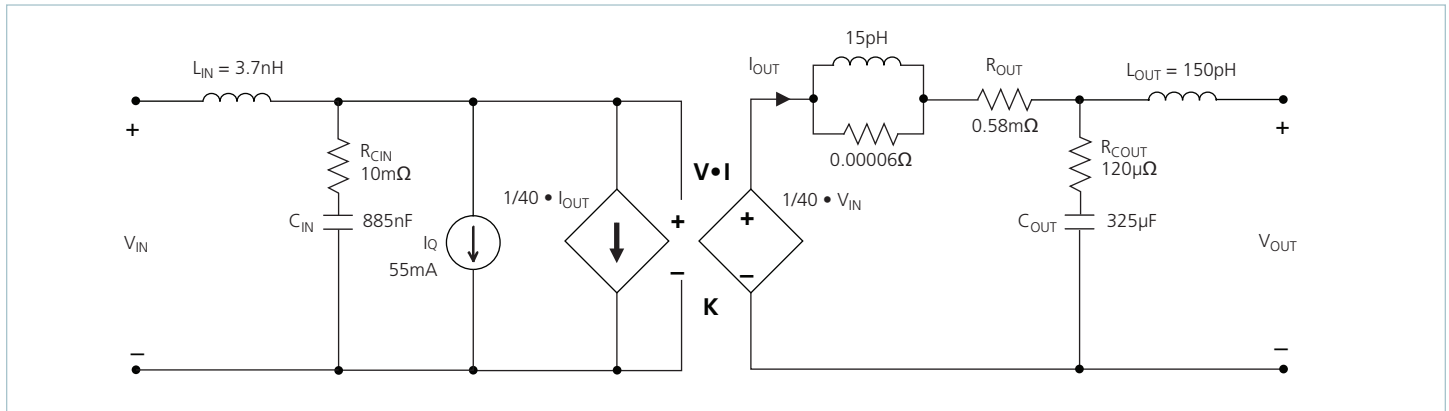


Figure 17 — VI Chip® product AC model

The Sine Amplitude Converter (SAC) uses a high frequency resonant tank to move energy from input to output. (The resonant tank is formed by Cr and leakage inductance Lr in the power transformer windings). The resonant LC tank, operated at high frequency, is amplitude modulated as a function of input voltage and output current. A small amount of capacitance embedded in the input and output stages of the module is sufficient for full functionality and is key to achieving power density.

The VTM48EF012T130C01 SAC can be simplified into the following model: At no load:

$$V_{OUT} = V_{IN} \cdot K \tag{1}$$

K represents the “turns ratio” of the SAC. Rearranging Eq (1):

$$K = \frac{V_{OUT}}{V_{IN}} \tag{2}$$

In the presence of load, V_{OUT} is represented by:

$$V_{OUT} = V_{IN} \cdot K - I_{OUT} \cdot R_{OUT} \tag{3}$$

and I_{OUT} is represented by:

$$I_{OUT} = \frac{I_{IN} - I_Q}{K} \tag{4}$$

R_{OUT} represents the impedance of the SAC, and is a function of the R_{dson} of the input and output MOSFETs and the winding resistance of the power transformer. I_q represents the quiescent current of the SAC control and gate drive circuitry.

The use of DC voltage transformation provides additional interesting attributes. Assuming that R_{out} = 0Ω and I_q = 0A, Eq. (3) now becomes Eq. (1) and is essentially load independent, resistor R is now placed in series with V_{IN} as shown in Figure 18.

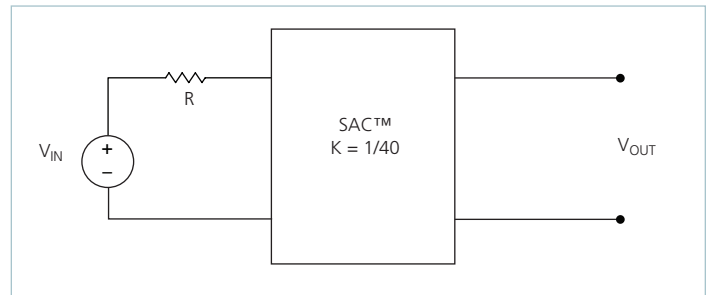


Figure 18 – K = 1/40 Sine Amplitude Converter with series input resistor

The relationship between V_{IN} and V_{OUT} becomes:

$$V_{OUT} = (V_{IN} - I_{IN} \cdot R) \cdot K \tag{5}$$

Substituting the simplified version of Eq. (4) (I_q is assumed = 0A) into Eq. (5) yields:

$$V_{OUT} = V_{IN} \cdot K - I_{OUT} \cdot R \cdot K^2 \tag{6}$$

This is similar in form to Eq. (3), where R_{out} is used to represent the characteristic impedance of the SAC™. However, in this case a real R on the input side of the SAC is effectively scaled by K^2 with respect to the output.

Assuming that $R = 1\Omega$, the effective R as seen from the secondary side is $0.63m\Omega$, with $K = 1/40$ as shown in Figure 18.

A similar exercise should be performed with the addition of a capacitor or shunt impedance at the input to the SAC. A switch in series with V_{IN} is added to the circuit. This is depicted in Figure 19.

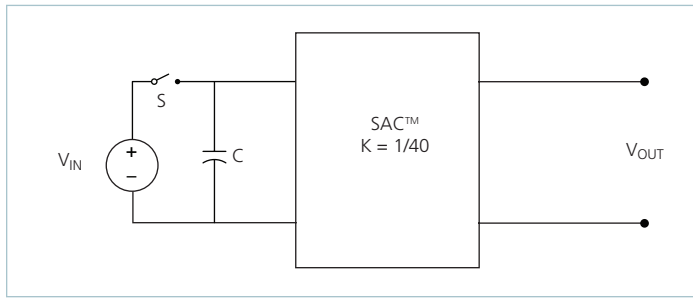


Figure 19 — Sine Amplitude Converter™ with input capacitor

A change in V_{IN} with the switch closed would result in a change in capacitor current according to the following equation:

$$I_C(t) = C \frac{dV_{IN}}{dt} \quad (7)$$

Assume that with the capacitor charged to V_{IN} , the switch is opened and the capacitor is discharged through the idealized SAC. In this case,

$$I_C = I_{OUT} \cdot K \quad (8)$$

Substituting Eq. (1) and (8) into Eq. (7) reveals:

$$I_{OUT} = \frac{C}{K^2} \cdot \frac{dV_{OUT}}{dt} \quad (9)$$

The equation in terms of the output has yielded a K^2 scaling factor for C, specified in the denominator of the equation.

A K factor less than unity, results in an effectively larger capacitance on the output when expressed in terms of the input. With a $K = 1/40$ as shown in Figure 19, $C = 1\mu F$ would appear as $C = 1600\mu F$ when viewed from the output.

Low impedance is a key requirement for powering a high-current, low voltage load efficiently. A switching regulation stage should have minimal impedance while simultaneously providing appropriate filtering for any switched current. The use of a SAC between the regulation stage and the point of load provides a dual benefit of scaling down series impedance leading back to the source and scaling up shunt capacitance or energy storage as a function of its K factor squared. However, the benefits are not useful if the series impedance of the SAC is too high. The impedance of the SAC must be low, i.e. well beyond the crossover frequency of the system.

A solution for keeping the impedance of the SAC low involves switching at a high frequency. This enables small magnetic components because magnetizing currents remain low. Small magnetics mean small path lengths for turns. Use of low loss core material at high frequencies also reduces core losses.

The two main terms of power loss in the VTM module are:

- No load power dissipation (P_{NL}): defined as the power used to power up the module with an enabled powertrain at no load.
- Resistive loss (R_{OUT}): refers to the power loss across the VTM current multiplier modeled as pure resistive impedance.

$$P_{DISSIPATED} = P_{NL} + P_{ROUT} \quad (10)$$

Therefore,

$$P_{OUT} = P_{IN} - P_{DISSIPATED} = P_{IN} - P_{NL} - P_{ROUT} \quad (11)$$

The above relations can be combined to calculate the overall module efficiency:

$$\eta = \frac{P_{OUT}}{P_{IN}} = \frac{P_{IN} - P_{NL} - P_{ROUT}}{P_{IN}} \quad (12)$$

$$= \frac{V_{IN} \cdot I_{IN} - P_{NL} - (I_{OUT})^2 \cdot R_{OUT}}{V_{IN} \cdot I_{IN}}$$

$$= 1 - \left(\frac{P_{NL} + (I_{OUT})^2 \cdot R_{OUT}}{V_{IN} \cdot I_{IN}} \right)$$

Input and Output Filter Design

A major advantage of a SAC™ system versus a conventional PWM converter is that the former does not require large functional filters. The resonant LC tank, operated at extreme high frequency, is amplitude modulated as a function of input voltage and output current and efficiently transfers charge through the isolation transformer. A small amount of capacitance embedded in the input and output stages of the module is sufficient for full functionality and is key to achieving high power density.

This paradigm shift requires system design to carefully evaluate external filters in order to:

1. Guarantee low source impedance.

To take full advantage of the VTM current multiplier dynamic response, the impedance presented to its input terminals must be low from DC to approximately 5MHz. Input capacitance may be added to improve transient performance or compensate for high source impedance.

2. Further reduce input and/or output voltage ripple without sacrificing dynamic response.

Given the wide bandwidth of the VTM module, the source response is generally the limiting factor in the overall system response. Anomalies in the response of the source will appear at the output of the VTM module multiplied by its K factor.

3. Protect the module from overvoltage transients imposed by the system that would exceed maximum ratings and cause failures.

The VI Chip® module input/output voltage ranges must not be exceeded. An internal overvoltage lockout function prevents operation outside of the normal operating input range. Even during this condition, the powertrain is exposed to the applied voltage and power MOSFETs must withstand it.

Capacitive Filtering Considerations for a Sine Amplitude Converter™

It is important to consider the impact of adding input and output capacitance to a Sine Amplitude Converter on the system as a whole. Both the capacitance value and the effective impedance of the capacitor must be considered.

A Sine Amplitude Converter has a DC Rout value which has already been discussed on Page 12. The AC Rout of the SAC contains several terms:

- Resonant tank impedance
- Input lead inductance and internal capacitance
- Output lead inductance and internal capacitance

The values of these terms are shown in the behavioral model on Page 12. It is important to note on which side of the transformer these impedances appear and how they reflect across the transformer given the K factor.

The overall AC impedance varies from model to model. For most models it is dominated by DC R_{OUT} value from DC to beyond 500KHz. The behavioral model on Page 12 should be used to approximate the AC impedance of the specific model.

Any capacitors placed at the output of the VTM reflect back to the input of the VTM module by the square of the K factor (Eq. 9) with the impedance of the VTM module appearing in series. It is very important to keep this in mind when using a PRM™ regulator to power the VTM module. Most PRM modules have a limit on the maximum amount of capacitance that can be applied to the output. This capacitance includes both the PRM output capacitance and the VTM module output capacitance reflected back to the input. In PRM remote sense applications, it is important to consider the reflected value of VTM module output capacitance when designing and compensating the PRM control loop.

Capacitance placed at the input of the VTM module appear to the load reflected by the K factor with the impedance of the VTM module in series. In step-down ratios, the effective capacitance is increased by the K factor. The effective ESR of the capacitor is decreased by the square of the K factor, but the impedance of the module appears in series. Still, in most step-down VTM modules an electrolytic capacitor placed at the input of the module will have a lower effective impedance compared to an electrolytic capacitor placed at the output. This is important to consider when placing capacitors at the output of the module. Even though the capacitor may be placed at the output, the majority of the AC current will be sourced from the lower impedance, which in most cases will be the module. This should be studied carefully in any system design using a module. In most cases, it should be clear that electrolytic output capacitors are not necessary to design a stable, well-bypassed system.

Current Sharing

The SAC™ topology bases its performance on efficient transfer of energy through a transformer without the need of closed loop control. For this reason, the transfer characteristic can be approximated by an ideal current multiplier with some resistive drop and positive temperature coefficient.

This type of characteristic is close to the impedance characteristic of a DC power distribution system, both in behavior (AC dynamic) and absolute value (DC dynamic).

When connected in an array with the same K factor, the VTM module will inherently share the load current (typically 5%) with parallel units according to the equivalent impedance divider that the system implements from the power source to the point of load.

Some general recommendations to achieve matched array impedances:

- Dedicate common copper planes within the PCB to deliver and return the current to the modules.
- Provide the PCB layout as symmetric as possible.
- Apply same input / output filters (if present) to each unit.

For further details see [AN:016 Using BCM® Bus Converters in High Power Arrays](#).

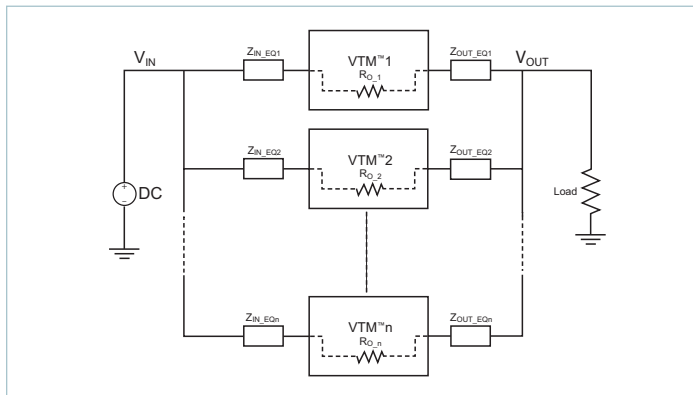


Figure 20 — VTM current multiplier array

Fuse Selection

In order to provide flexibility in configuring power systems VI Chip® products are not internally fused. Input line fusing of VI Chip products is recommended at system level to provide thermal protection in case of catastrophic failure.

The fuse shall be selected by closely matching system requirements with the following characteristics:

- Current rating (usually greater than maximum current of VTM module)
- Maximum voltage rating (usually greater than the maximum possible input voltage)
- Ambient temperature
- Nominal melting I^2t

Reverse Inrush Current Protection

The VTM48EF012T130C01 provides reverse inrush protection which prevents reverse current flow until the input voltage is high enough to first establish current flow in the forward direction. In the event that there is a DC voltage present on the output before the VTM module is powered up, this feature protects sensitive loads from excessive dV/dT during power up as shown in Figure 21.

If a voltage is present at the output of the VTM module which satisfies the condition $V_{OUT} > V_{IN} \cdot K$ after a successful power up the energy will be transferred from secondary to primary. The input to output ratio of the VTM module will be maintained. The VTM module will continue to operate in reverse as long as the input and output voltages are within the specified range. The VTM48EF012T130C01 has not been qualified for continuous reverse operation.

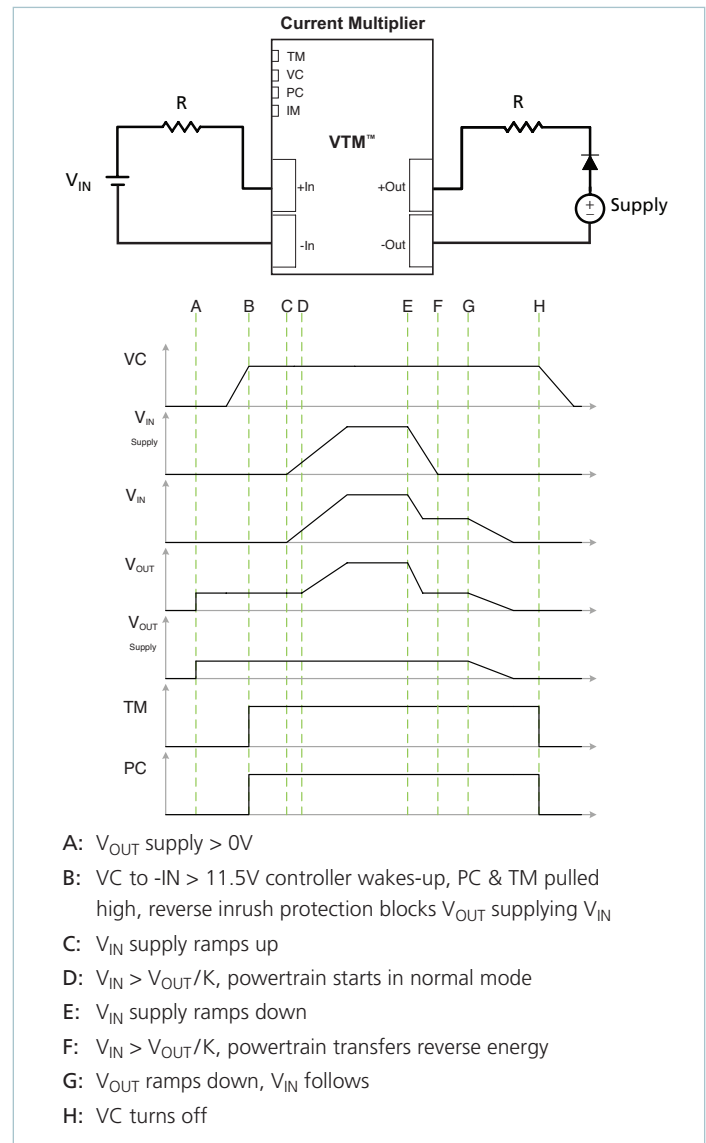


Figure 21 — Reverse inrush protection

Layout Considerations

The VTM48EF012T130C01 requires equal current density along the output J-leads to achieve rated efficiency and output power level. The negative output J-leads are not connected internally and must be connected on the board as close to the VTM current multiplier as possible. The layout must also prevent the high output current of the VTM48EF012T130C01 from interfering with the input-referenced signals.

To achieve these requirements, the following layout guidelines are recommended:

- The total current path length from any point on the V+OUT J-leads to the corresponding point on the V-OUT J-leads should be equal (see Figure 22).
- Use vias along the negative output J-leads to connect the negative output to a common power plane.
- Use sufficient copper weight and number of layers to carry the output current to the load or to the output connectors.
- Be sure to include enough vias along both the positive and negative J leads to distribute the current among the layers of the PCB.
- Do not run input-referenced signal traces (VC, PC, TM and IM) between the layers of the secondary outputs.
- Run the input-referenced signal traces (VC, PC, TM and IM) such that V-IN shields the signals. [See AN:005 FPA Printed Circuit Board Layout Guidelines](#) for more details.

Equalizing the current paths is most easily accomplished by centering the VTM module output J-leads between the output connections of the PCB and by designing the board such that the layout is symmetric from both sides of the output and from the front and back ends of the output as shown in Figures 23 and 24.

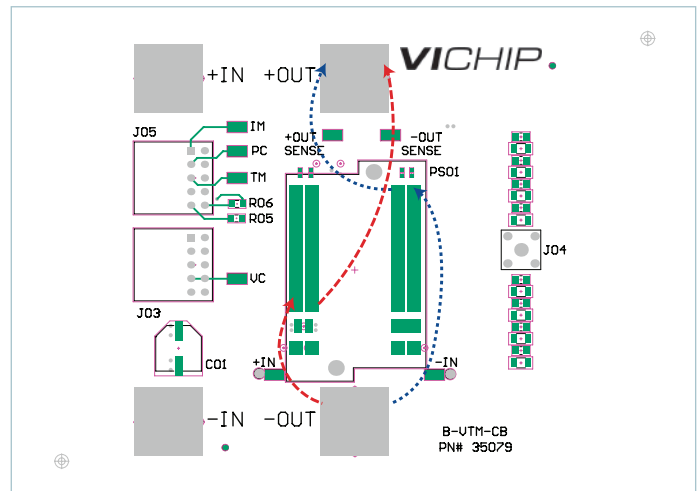


Figure 22 — Equal current path

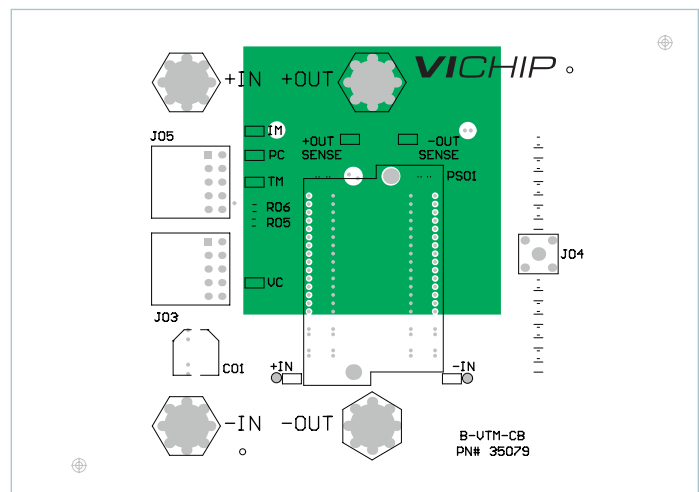


Figure 23 — Symmetric layout

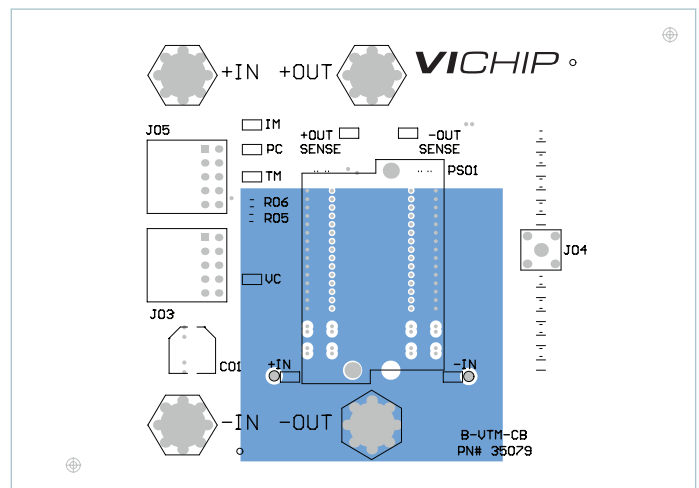
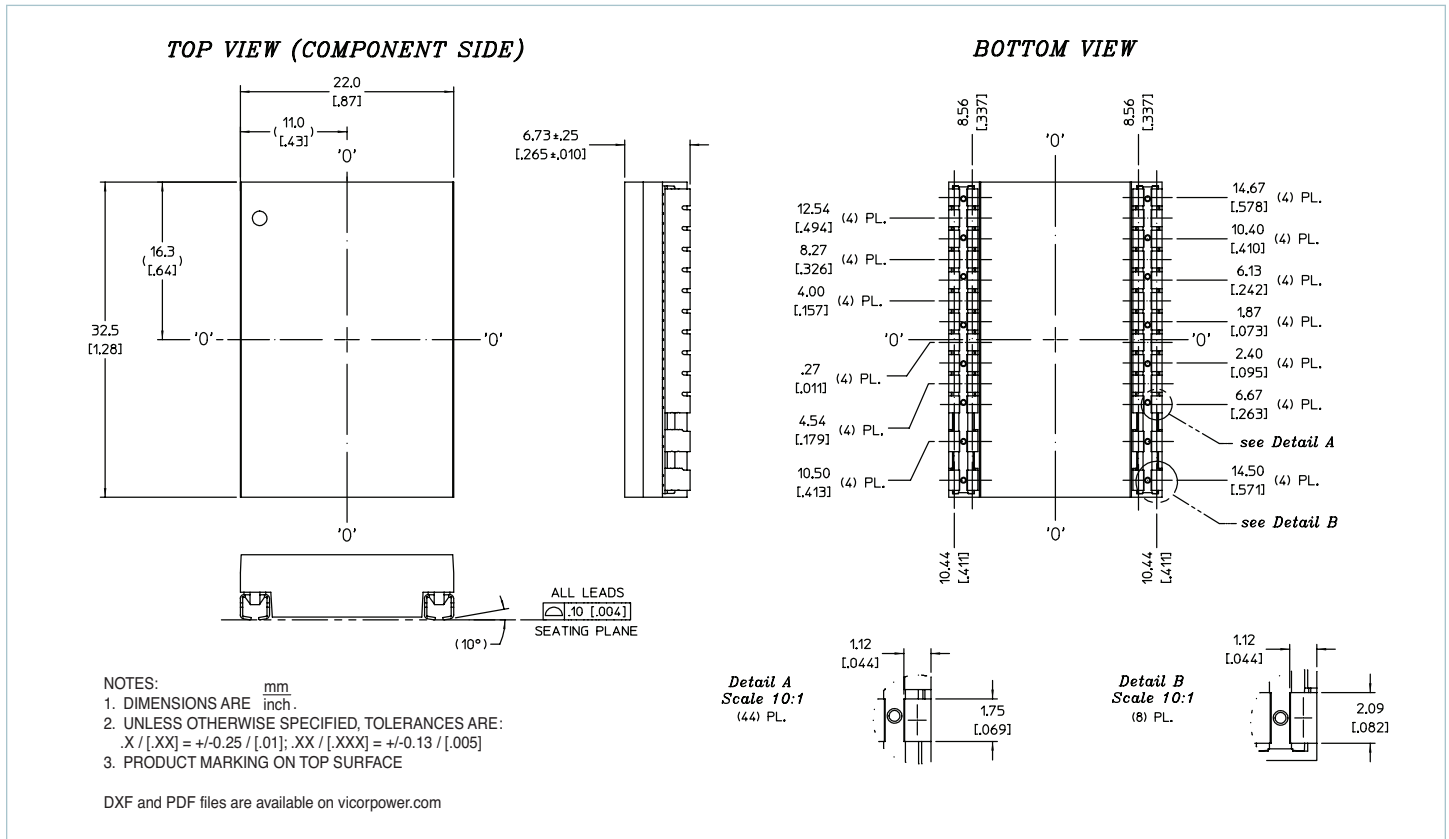
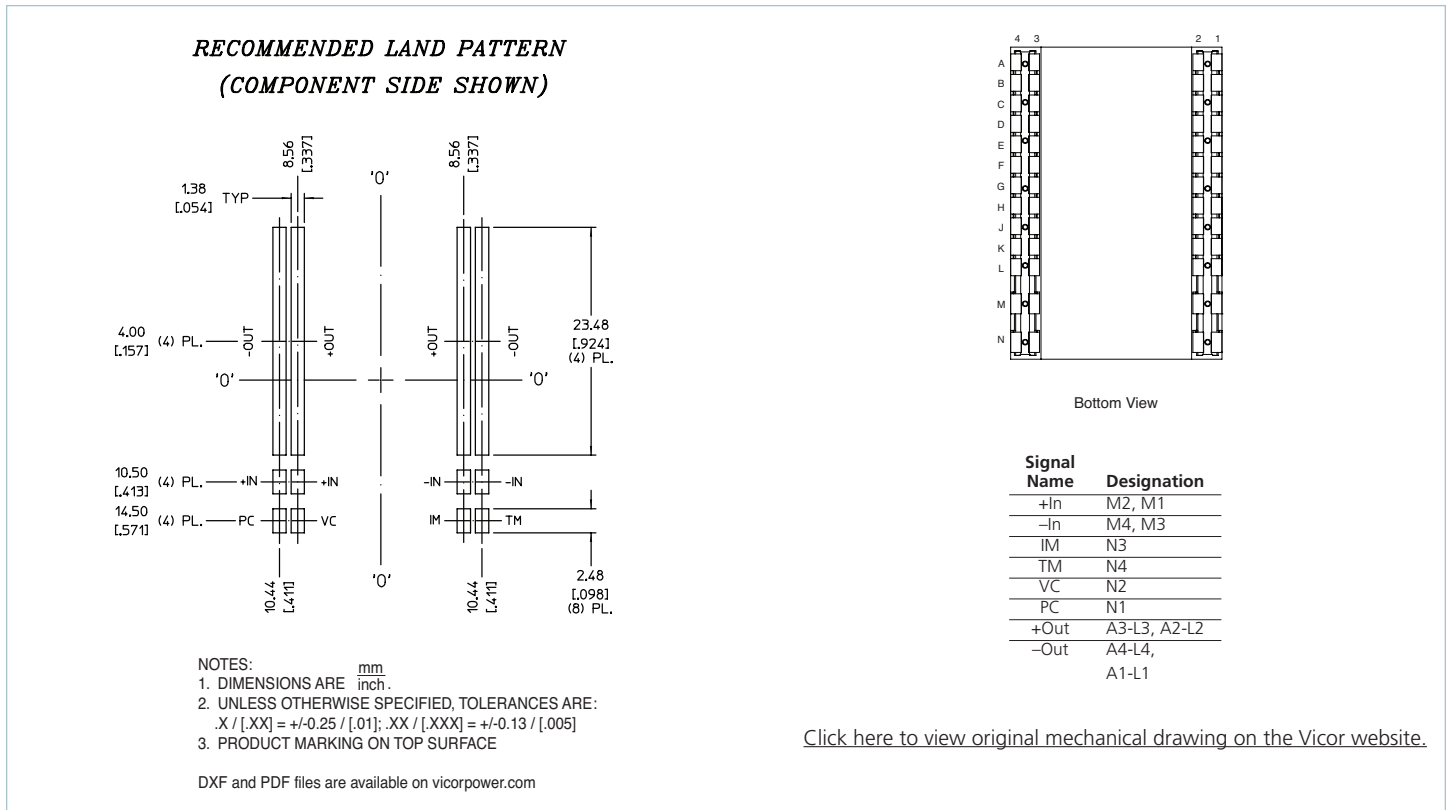


Figure 24 — Symmetric layout

Mechanical Drawing



Recommended Land Pattern



Revision History

Revision	Date	Description	Page Number(s)
1.0	05/16/15	Initial Release	n/a

Vicor's comprehensive line of power solutions includes high density AC-DC and DC-DC modules and accessory components, fully configurable AC-DC and DC-DC power supplies, and complete custom power systems.

Information furnished by Vicor is believed to be accurate and reliable. However, no responsibility is assumed by Vicor for its use. Vicor makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication. Vicor reserves the right to make changes to any products, specifications, and product descriptions at any time without notice. Information published by Vicor has been checked and is believed to be accurate at the time it was printed; however, Vicor assumes no responsibility for inaccuracies. Testing and other quality controls are used to the extent Vicor deems necessary to support Vicor's product warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

Specifications are subject to change without notice.

Visit <http://www.vicorpower.com/dc-dc-converters-board-mount/vtm> for the latest product information.

Vicor's Standard Terms and Conditions and Product Warranty

All sales are subject to Vicor's Standard Terms and Conditions of Sale, and Product Warranty which are available on Vicor's webpage (<http://www.vicorpower.com/termsconditionswarranty>) or upon request.

Life Support Policy

VICOR'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF VICOR CORPORATION. As used herein, life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness. Per Vicor Terms and Conditions of Sale, the user of Vicor products and components in life support applications assumes all risks of such use and indemnifies Vicor against all liability and damages.

Intellectual Property Notice

Vicor and its subsidiaries own Intellectual Property (including issued U.S. and Foreign Patents and pending patent applications) relating to the products described in this data sheet. No license, whether express, implied, or arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Interested parties should contact Vicor's Intellectual Property Department.

The products described on this data sheet are protected by the following U.S. Patents Numbers:

5,945,130; 6,403,009; 6,710,257; 6,911,848; 6,930,893; 6,934,166; 6,940,013; 6,969,909; 7,038,917; 7,145,186; 7,166,898; 7,187,263; 7,202,646; 7,361,844; D496,906; D505,114; D506,438; D509,472; and for use under 6,975,098 and 6,984,965.

Contact Us: <http://www.vicorpower.com/contact-us>

Vicor Corporation
25 Frontage Road
Andover, MA, USA 01810
Tel: 800-735-6200
Fax: 978-475-6715
www.vicorpower.com

email

Customer Service: custserv@vicorpower.com
Technical Support: apps@vicorpower.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vicor:

[VTM48EF012T130C01](#)

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».



JONHON

«**JONHON**» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«**FORSTAR**» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А